

DECLARATION FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled hKIS COMPOSITIONS AND METHODS OF USE, the specification of which:

- ☐ is attached hereto.
- ☒ was filed on August 20, 1999 as Application Serial No. 09/378,517.
- ☐ and was amended on _____ (if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the patentability as defined in Title 37, Code of Federal Regulations, § 1.56(a).

I hereby claim foreign priority benefits under 35 U.S.C. § 119(a)-(d) or § 365(b) of any foreign application(s) for patent or inventor's certificate or § 365(a) of any PCT International application which designated at least one country other than the United States, listed below and have also identified below, by checking the box, any foreign application for patent or inventor's certificate, or PCT International application having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)

Priority Claimed

_____	_____	_____	<input type="checkbox"/>	<input type="checkbox"/>
(Number)	(Country)	(Day/Month/Year Filed)	Yes	No

I hereby claim the benefit under 35 U.S.C. § 119(e) of any United States provisional application(s) listed below:

<u>60/097,710</u>	<u>August 21, 1998</u>
(Application Serial No.)	(Filing Date)

I hereby claim the benefit under 35 U.S.C. § 120 of any United States application(s), or § 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of 35 U.S.C. § 112, I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application:

_____	_____	None
(Application Serial No.)	(Filing Date)	(Status-patented, pending, abandoned)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Inventor's Signature

Full name of sole or first inventor

Residence

Citizenship

Post Office Address

Gary J. Mabel Date: 11/22/99
Gary J. Mabel
Washington, D.C. 20008
United States of America
2520 30th Street N.W., Washington, D.C. 20008

BRINKS HOFER GILSON & LIONE
P.O. Box 10395
Chicago, IL 60610
(312) 321-4200

Inventor's Signature
 Full name of second joint inventor, if any
 Residence
 Citizenship
 Post Office Address

Elizabeth S. Nabel

Date: 11/22/99

Elizabeth S. Nabel

Washington, D.C. 20008

United States of America

2520 10th Street N.W., Washington, D.C. 20008

Inventor's Signature
 Full name of third joint inventor
 Residence
 Citizenship
 Post Office Address

Manfred Boehm

Manfred Boehm

Date: 11/22/99

Manfred Boehm

Potomac, Maryland

German

12301 St. James Road, Potomac, Maryland 20854

Inventor's Signature
 Full name of fourth joint inventor
 Residence
 Citizenship
 Post Office Address

Date: _____

Inventor's Signature
 Full name of fifth joint inventor
 Residence
 Citizenship
 Post Office Address

Date: _____

Inventor's Signature
 Full name of sixth joint inventor
 Residence
 Citizenship
 Post Office Address

Date: _____

Inventor's Signature
 Full name of seventh joint inventor
 Residence
 Citizenship
 Post Office Address

Date: _____